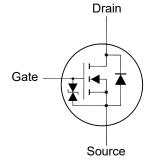
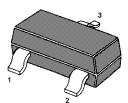
N-Channel Enhancement Mode MOSFET

Features

- Surface-mounted package
- Built-in G-S Protection Diode
- Typical ESD Protection HBM Class 2

Classification	Voltage Range(V)		
0A	< 125		
0B	125 to < 250		
1A	250 to < 500		
1B	500 to < 1000		
1C	1000 to < 2000		
2	2000 to < 4000		
3A	4000 to < 8000		
3B	≥ 8000		





1. Gate 2. Source 3. Drain SOT-23 Plastic Package

Application

- Portable appliances
- Battery management

Absolute Maximum Ratings (at Ta = 25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain Source Voltage	V _{DS}	100	V
Gate Source Voltage	V _{GS}	± 20	V
Drain Current	lo	1	A
Peak Drain Current, Pulsed ¹⁾	Ідм	4	A
Power Dissipation ²⁾	PD	1	W
Operating Junction and Storage Temperature Range	Tj, Tstg	- 55 to + 150	°C

Thermal Resistance Ratings

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Ambient ²⁾	R _{θJA}	125	°C/W

¹⁾ Pulse Test: Pulse Width \leq 100 µs, Duty Cycle \leq 2%, Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}.

²⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate in still air.

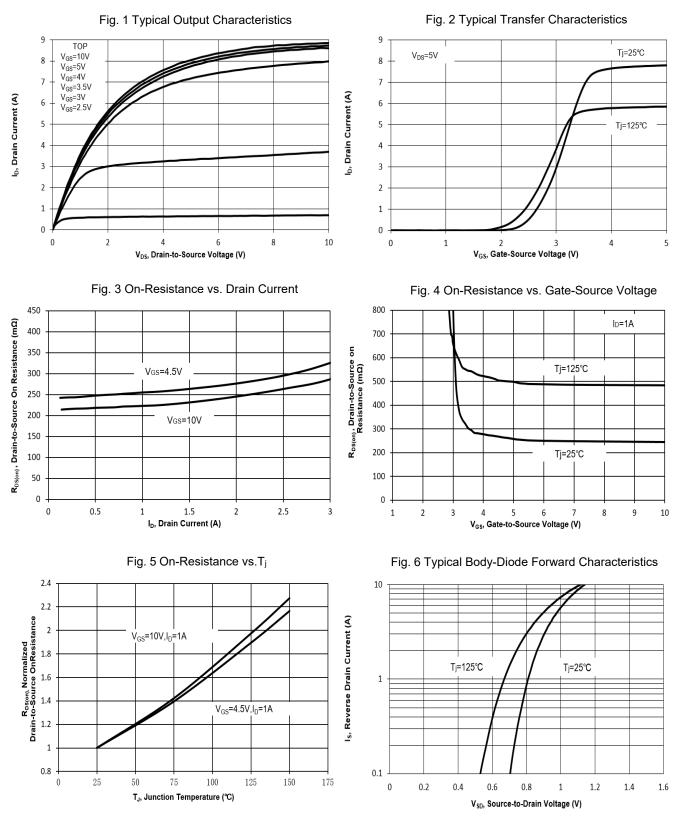


Characteristics at Ta = 25°C unless otherwise specified

Parameter	Symbol	Min.	Тур.	Max.	Unit
STATIC PARAMETERS					
Drain-Source Breakdown Voltage at I _D = 1 mA	BV _{DSS}	100	-	-	V
Drain-Source Leakage Current at V _{DS} = 100 V	I _{DSS}	-	-	1	μA
Gate-Source Leakage at V _{GS} = ± 20 V	I _{GSS}	-	-	± 10	μA
Gate-Source Threshold Voltage at V _{DS} = 10 V, I _D = 1 mA	V _{GS(th)}	1	-	2.5	V
Drain-Source On-State Resistance at $V_{GS} = 10 \text{ V}$, $I_D = 1 \text{ A}$ at $V_{GS} = 4.5 \text{ V}$, $I_D = 1 \text{ A}$ at $V_{GS} = 4 \text{ V}$, $I_D = 1 \text{ A}$	$R_{\text{DS(on)}}$	- - -	- - -	520 560 580	mΩ
DYNAMIC PARAMETERS					_
Forward Transconductance at V_{DS} = 5 V, I_{D} = 1 A	gfs	-	4.1	-	S
Gate resistance at V _{DS} = 0 V, V _{GS} = 0 V, f = 1 MHz	R _g	-	0.9	-	Ω
Input Capacitance at V _{GS} = 0 V, V _{DS} = 50 V, f = 1 MHz	C _{iss}	-	454	-	pF
Output Capacitance at V _{GS} = 0 V, V _{DS} = 50 V, f = 1 MHz	C _{oss}	-	17	-	pF
Reverse Transfer Capacitance at V_{GS} = 0 V, V_{DS} = 50 V, f = 1 MHz	C _{rss}	-	13	-	pF
Gate charge total at V_{DS} = 50 V, V_{GS} = 10 V, I_D = 1 A at V_{DS} = 50 V, V_{GS} = 4.5 V, I_D = 1 A	Qg	-	8.4 3.9	-	nC
Gate to Source Charge at V_{DS} = 50 V, V_{GS} = 10 V, I_D = 1 A	Q _{gs}	-	1.9	-	nC
Gate to Drain Charge at V _{DS} = 50 V, V _{GS} = 10 V, I _D = 1 A	Q _{gd}	-	1.1	-	nC
Turn-On Delay Time at V _{DS} = 50 V, V _{GS} = 10 V, I _D = 1 A, R _g = 3.3 Ω	t _{d(on)}	-	9.5	-	nS
Turn-On Rise Time at V _{DS} = 50 V, V _{GS} = 10 V, I _D = 1 A, R _g = 3.3Ω	tr	-	4	-	nS
Turn-Off Delay Time at V _{DS} = 50 V, V _{GS} = 10 V, I _D = 1 A, R _g = 3.3Ω	t _{d(off)}	-	8	-	nS
Turn-Off Fall Time at V _{DS} = 50 V, V _{GS} = 10 V, I _D = 1 A, R _g = 3.3 Ω	t _f	-	13	-	nS
Body-Diode PARAMETERS			1	I	
Diode Forward Voltage at Is = 1 A, V _{GS} = 0 V	Vsd	-	-	1.2	V
Body-Diode Continuous Current	ls	-	-	1	А
Body Diode Reverse Recovery Time at Is = 1 A, di/dt = 100 A / μs	t _{rr}	-	17	-	nS
Body Diode Reverse Recovery Charge at I _s = 1 A, di/dt = 100 A / μs	Qrr	-	14.5	-	nC

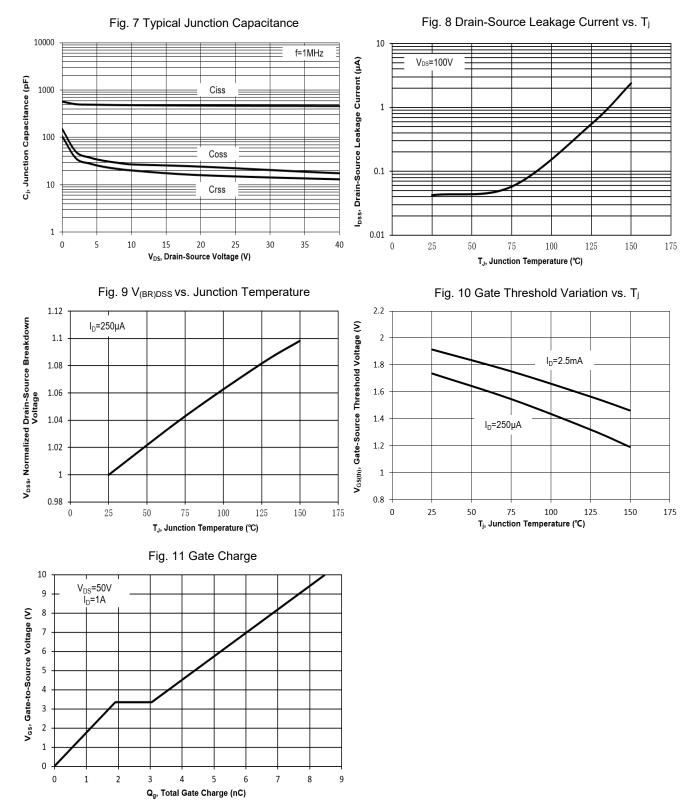


Electrical Characteristics Curves





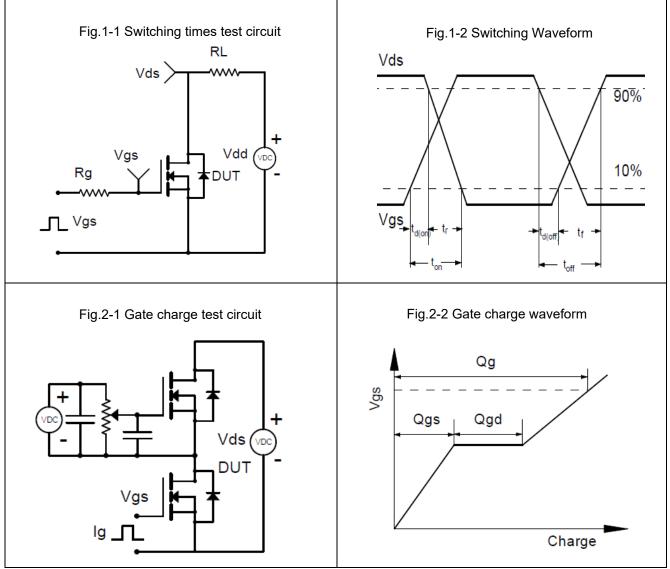
Electrical Characteristics Curves





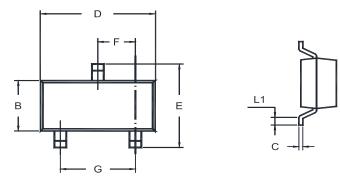
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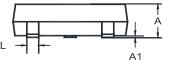






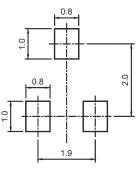
Package Outline (Dimensions in mm)





Unit	А	A1	В	С	D	E	F	G	L	L1
2010	1.20	0.100	1.40	0.19	3.04	2.6	1.02	2.04	0.51	0.2
mm	0.89	0.013	1.20	0.08	2.80	2.2	0.89	1.78	0.37	MIN

Recommended Soldering Footprint

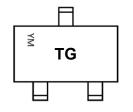


Packing information

Tape Width		Pit	tch	Reel	Size		
Package	(mm)	mm	inch	mm	inch	Per Reel Packing Quantity	
SOT-23	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000	

Marking information

- " TG " = Part No.
- " YM " = Date Code Marking
- " Y " = Year
- " M " = Month
- Font type: Arial



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SOT-23